

- Designed for GSM BTS Receiver IF Applications
- Simple External Impedance Matching
- Hermetic SMP-87 Surface-mount Case
- Unbalanced Input and Output
- Extended Temperature Range Version of SF1081A
- Complies with Directive 2002/95/EC (RoHS)

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

AEC-Q200 This component was always RoHS compliant from the first date of manufacture.

SF1081A-1

RoHS

Compliant

71.00 MHz SAW Filter



Electrical Characteristics

Characteristic		Sym	Notes	Min	Тур	Max	Units	
Nominal Center F	requency	f _C			71.000		MHz	
Passband	Insertion Loss at fc	IL			6	8.0	dB	
	3 dB Passband	BW ₃		±100	±140	±200	kHz	
	Amplitude Ripple over fc ±80 kHz					1.5	dB _{P-P}	
Group Delay Variation over fc ±50 kHz		GDV			300	1000	ns _{P-P}	
	Absolute Group Delay	GD			2.8		μs	
Rejection	fc-600 to fc-400 and fc+400 to fc+600 kHz			25	26			
	fc-1.0 to fc-0.6 and fc+0.6 to fc+1.8 MHz			35	40			
	69.6 to 70.0 MHz			40	45		ав	
31 to 69.6 and 71.8 to 111 MHz				35	50			
Operating Temperature Range		Τ _Α		-40		+85	°C	
Impedance Matching to 50 Ω unbalanced				Ext	ernal L-C			
Case Style		SMP-87 22.1 X 8 mm Nominal Footprint						
Lid Symbolization (YY=year, WW=week, S=shift, ##=lot))		RFM SF1081A-1 YYWWS##						



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.



SMP-87 Case

10-Terminal Ceramic Surface-Mount Case 22.1 x 8 mm Nominal Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Мах
Α	21.90	22.10	22.40	0.862	0.870	0.882
В	7.80	8.00	8.30	0.307	0.315	0.327
С		1.78	2.00		0.070	0.079
D		2.29			0.090	
E		1.02			0.040	
Н		1.0			0.039	
м		4.83			0.190	
N		2.41			0.095	
Р		1.905			0.075	

Electrical Connections				
Connection		Terminals		
Port 1	Input or Return	10		
FUILI	Return or Input	1		
Port 2	Output or Return	5		
	Return or Output	6		
	Ground	All others		
Single-ended Operation		Return is ground		
Differential Operation		Return is hot		



Materials	
Solder Pad Plating	1.015 μm Gold minimum over 2.030 μm Nickel
Lid Plating	2.0 to 3.0 µm Nickel
Body	Al ₂ O ₃ Ceramic
	Pb Free

Recommended Reflow Profile

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

